The technology of symmetric copper pairs continues to evolve and ensures transmissions at ever higher frequencies (e.g. cat 8 or the upcoming 40GBASE-T). To secure their specifications, manufacturers shall have suitable test equipment. AESA has introduced the first automatic testing equipment with the "balunless" technology. It opens the door to the measurement of multiple new parameters.

It is essential to understand and control them since they offer new opportunities in measurement technology to help finding the cause of marginal or failing lots in production by analysing single-ended S-parameters. This method allows by mathematical superposition of single-ended measurements to get the well-known mixed-mode S-parameters. The purpose of this application note is to share knowledge about this method and related parameters.

**INTRODUCTION**

Traditionally data cables are tested with a balun at each end of the cable. The limited bandwidth was sufficient for lower categories and common and mixed-mode S-parameters not required or difficult to evaluate.

At higher maximum frequency these parameters get more and more important. According to IEC 61156-5 balance requirements are given only up to 250 MHz because of balun restrictions.

In the meantime the industry rediscovered the symmetry parameters again because a higher percentage of failures could be traced back to TCL and EL TCTL.

**Fig.2: Example of balunless testing: Insertion Loss**

In Fig. 1 & 2, the principle of Insertion Loss measurement with and without balun is shown. The most obvious point beside the use of baluns or not is the number of VNA ports which are needed to get the same S-parameter. More ports means also more sweeps leading to a longer test time.

What is the reason why balunless testing should be in preference? We will see later that in the same sweep we get not only the well-known differential-mode Insertion Loss $S_{dd}$, but also the common-mode Insertion Loss $S_{cc}$, the single ended Insertion Loss $S_{13}$ and $S_{24}$ as well as the in pair FEXT $S_{14}$ and $S_{23}$. 
THEORETICAL BACKGROUND
As described by Fan et al (2003), the key is a conversion of single-ended S-parameters into mixed-mode S-parameters.

Therefore the 4-Port device can be mathematically represented by single-ended S-parameters and the waves going into the DUT (a) and the waves which come out of the DUT (b).

\[
\begin{bmatrix}
    b_1 \\
    b_2 \\
    b_3 \\
    b_4 \\
\end{bmatrix} =
\begin{bmatrix}
    S_{11} & S_{12} & S_{13} & S_{14} \\
    S_{21} & S_{22} & S_{23} & S_{24} \\
    S_{31} & S_{32} & S_{33} & S_{34} \\
    S_{41} & S_{42} & S_{43} & S_{44} \\
\end{bmatrix}
\begin{bmatrix}
    a_1 \\
    a_2 \\
    a_3 \\
    a_4 \\
\end{bmatrix}
\]

Fig.4: single-ended matrix representation

In a similar way the same DUT can be represented as a 2-Port differential device:

Fig.5: 2-Port differential device (mixed-mode)

A mixed-mode S-matrix can be organised similarly to the single-ended S-matrix:

\[
\begin{bmatrix}
    b_{d1} \\
    b_{d2} \\
    b_{c1} \\
    b_{c2} \\
\end{bmatrix} =
\begin{bmatrix}
    S_{dd11} & S_{dd12} & S_{dc11} & S_{dc12} \\
    S_{dd21} & S_{dd22} & S_{dc21} & S_{dc22} \\
    S_{cd11} & S_{cd12} & S_{cc11} & S_{cc12} \\
    S_{cd21} & S_{cd22} & S_{cc21} & S_{cc22} \\
\end{bmatrix}
\begin{bmatrix}
    a_{d1} \\
    a_{d2} \\
    a_{c1} \\
    a_{c2} \\
\end{bmatrix}
\]

Fig.6: 2-Port differential matrix representation

With comparison between both cases, single-ended and mixed-mode, the mathematical correlation for each mixed-mode S-parameter can be found and explained by a combination of 4 single-ended S-parameters.

The resulting mixed-mode S-matrix consists of differential-mode to differential-mode (yellow), common-mode to common-mode (green) and mixed-mode (common-mode to differential-mode (blue) and differential-mode to common-mode (pink) S-parameters:

\[
S_{mm} =
\begin{bmatrix}
    S_{dd11} & S_{dd12} & S_{dc11} & S_{dc12} \\
    S_{dd21} & S_{dd22} & S_{dc21} & S_{dc22} \\
    S_{cd11} & S_{cd12} & S_{cc11} & S_{cc12} \\
    S_{cd21} & S_{cd22} & S_{cc21} & S_{cc22} \\
\end{bmatrix}
\]

Fig.7: mixed-mode matrix

As a reading example the following formula can be taken:

\[
R_{Ldd} @ \text{Port 1} : S_{dd11} = \frac{1}{2} (S_{11} - S_{13} - S_{31} + S_{33})
\]

\[
S_{mm} = \frac{1}{2}
\begin{bmatrix}
    S_{11} - S_{13} - S_{31} + S_{33} & S_{12} - S_{14} - S_{32} + S_{34} \\
    S_{21} - S_{23} - S_{41} + S_{43} & S_{22} - S_{24} - S_{42} + S_{44} \\
    S_{31} - S_{33} - S_{11} + S_{13} & S_{32} - S_{34} - S_{12} + S_{14} \\
    S_{41} - S_{43} - S_{21} + S_{23} & S_{42} - S_{44} - S_{22} + S_{24} \\
\end{bmatrix}
\]

Fig.8: transformation matrix between single-ended S-parameters and mixed-mode S-parameters

The transformation matrix is the base of the following discussion and analyses. Explanation to this formula and some others will be given in the following parts with examples.
CASE 1: LOW RL

As shown above the RL @ Port 1 is represented by $S_{dd11}$:

$$S_{dd11} = \frac{1}{2}(S_{11} - S_{13} - S_{31} + S_{33})$$

Here we have an example of RL measurement as it can be taken also with baluns.

The measurement shows a Pass with a marginal margin of 0.2 dB. For a cable manufacturer it can be ok but probably he was just lucky to get a Pass. For balun testing the story ends here. It is not possible to further evaluate the cause of the marginal measurement.

With the ability of balunless testing the cable manufacturer has much more opportunities to go deeper into single-ended measurements.

From the given formula for Return Loss we can find the 4 single-ended S-parameters. $S_{11}$ and $S_{33}$ are the single-ended Return Loss measurements of “a” wire and “b” wire of the pair. $S_{13}$ and $S_{31}$ are the crosstalk measurements from “a” wire to “b” wire and from “b” wire to “a” wire.

The overlay of the single-ended NEXT measurements $S_{13}$ and $S_{31}$ shows no noteworthy deviation over the whole frequency range. In contrast the single-ended RL measurements $S_{11}$ and $S_{33}$ show diverting values at 100 MHz and above.

These differences are causing the poor RL performance of near end. In this specific case wire “b” is worse than wire “a”.

As written above there are even more opportunities with single-ended measurements. We can also compare the impedances of each wire.

The final conclusion with access to single-ended S-parameters is imposing itself now:

The increasing impedance of wire “b” causes a bad single-ended RL performance which results in a bad differential-mode RL.

The access to single-ended S-parameters revealed the cause of poor performance which would stay completely hidden with balun based measurement technology.
CASE 2: FAILING TCL

If we consider our transformation matrix above we find for TCL ($S_{cd11}$) the following formula:

$$S_{cd11} = \frac{1}{2} (S_{11} - S_{13} + S_{31} - S_{33})$$

The example given below shows a well-known artefact in data cables, a peak in TCL. Today’s balun based test equipment’s are rarely providing access to the centre tap. This is caused by worse performance of the balun itself if this access is provided. Normally additional test equipment is required to do symmetry measurements.

![TCL measurement far end](image1)

Fig. 13: TRL measurement far end

Here we end with balun measurements. There is no way to find out what the cause of this peak is. Only single-ended measurements can provide the needed answers.

The formula above shows that the same S-parameters as for Return Loss are required. Only the algebraic signs are exchanged.

The comparison of the single-ended NEXT measurements $S_{13}$ and $S_{31}$ and the single-ended RL measurements $S_{11}$ and $S_{33}$ will give some further hints.

![Single-ended NEXT measurements $S_{13}$ and $S_{31}$](image2)

Fig. 14: Single-ended NEXT measurements $S_{13}$ and $S_{31}$

![Difference of $S_{13}$ and $S_{31}$](image3)

Fig. 16: Difference of $S_{13}$ and $S_{31}$

As expected, Delta NEXT is very small (much less than 0.1 dB) and can be neglected. Interestingly even on that level an indicator for a special effect in the cable can be seen as a sharp peak arises at 210 MHz.

![Single-ended RL measurements $S_{11}$ and $S_{33}$](image4)

Fig. 15: Single-ended RL measurements $S_{11}$ and $S_{33}$

Single-ended RL shows a completely different picture. The differences are increasing between the 2 graphs at 200 MHz and result finally in two peaks in opposite direction at the frequency of the TCL peak.

![Difference of $S_{11}$ and $S_{33}$](image5)

Fig. 17: Difference of $S_{11}$ and $S_{33}$
As seen above in the single-ended measurements a huge peak in Delta RL, which is close to 10 dB, can be found at 210 MHz, exactly the frequency where we also find the peak in TCL.

This could be considered as the final cause of the peak but for balunless testing and single-ended measurements still more information can be accessed.

If we have the single-ended RL values it is a short way to get the single-ended impedance of each wire.

At the critical frequency of 210 MHz wire “a” forms a peak down as wire “b” goes directly in the opposite direction. This can be expected from the single-ended RL measurement but it is not clear which wire shows a higher impedance and which one a lower impedance.

This behaviour can now be interpreted. As well known, higher impedance means more distance between two electrical conductors, here represented by the wire and the pair foil. Vice versa, lower impedance means less distance between the wire and the foil.

Finally it can be concluded that the mechanical structure of the pair is recurring, here approximately every meter, distorted during the production process in the wire extruder or afterwards during the stranding. The sharp peak indicates that the mechanical problem is very stable, repeatable and probably easy to locate, e.g. related to the diameter of a pulley.
CASE 3: IL RINGING
We define IL ringing as percentage of deviation between IL measured and IL limit. Instead of a smooth line we find oscillating values.

Fig.20: IL ringing at low frequencies

If we remember the transformation matrix we can find for IL (S_{d21}) this formula:

\[ S_{d21} = \frac{1}{2} (S_{21} - S_{23} - S_{41} + S_{43}) \]

The cause of IL ringing must be found in the single-ended S-parameters above, which are the Insertion Loss of wire “a” and wire “b”, S_{21} and S_{43} respectively and inter pair FEXT S_{23} and S_{41}. Inter pair FEXT is the signal which is sent in at “a” wire and is received at “b” wire at the far end of the cable.

Fig.21: single-ended IL and FEXT at low frequencies

All single-ended S-parameters have already some smooth waves but this is not the cause of IL ringing. To understand the IL ringing we have to compare the differences between IL of “a” wire and “b” wire respectively the difference of inter pair FEXT.

As given in the graph below the differences are in a similar range of a few hundredth of dB. In this case we have to compare the absolute levels of single-ended IL and FEXT. The single-ended IL is close to the IL values of the cable, here between -2 dB and -6 dB for frequencies below 10 MHz. The FEXT values are much smaller, here between -30 dB and -16 dB for the same frequency range. In absolute values IL is higher than FEXT and has because of that a higher influence.

Fig.22: Delta IL and Delta FEXT

Are these values bad? What kind of values can be expected? Here the VNA specification can help. Each analyser is specified on transmission uncertainty. This value is typically between 0.02 dB and 0.05 dB. Both values are clearly below the analyser specification. From that perspective we can consider the values as good and following this, the residual IL ringing is caused by the uncertainty of the used test equipment itself.

Fig.23: single-ended IL and FEXT and differential IL

As additional information we can study the overlay of all graphs, the 4 single-ended measurements (blue and green) and the resulting differential IL (red). Compared to the single-ended S-parameters differential IL is very smooth. Because of the differential data transmission we don’t care about if the signals are received on the same wire of the pair or not.

But if we have a look at the graph then we see that for most frequencies the signal is received on the other wire at far end.
CONCLUSION
The new opportunities as presented in this paper open a door for better understanding of data cable manufacturing and provide some insights about the way how single-ended S-parameters can be used to understand weaknesses of cables better.

As proven by many papers, mathematical superposition of single-ended S-parameters is very accurate. Additionally to the well-known differential S-parameters we get also mixed-mode and common-mode S-parameters which are based on the same single-ended measurements but distinguished by the algebraic signs in the formulae.

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All shown measurements in this document are done with an AESA Cobalt system. It is fully automated balunless test equipment which performs all electrical tests on cables responding to TIA*1183 and the upcoming TIA*1183-1 to test Category 8 cables and beyond.

Balunless testing is a great tool because it allows accessing data from each single wire and how they are interacting in the pair. This technology allows analysing the cable also during production and sorting out low performing pairs to reduce scrap and waste of material.

In such a way of thinking it helps to reduce development cost and reaction time, check and improve the quality during each production step and improve the factory’s efficiency. Thanks to such analysis a cable manufacturer can understand and control his production better and find weak points much faster.

Fig.24: AESA Cobalt automatic balunless measuring system.

FIGURES & REFERENCES
Fig.1  IEC 61935-1
Fig.2  IEC 61156-1-2 AMD 1
Fig.3,4,5,6,8  Fan et al (2003)
Fig.7  Fan et al (2011)
Fig.9 – 23  Measured with Cobalt
Fig.24  Cobalt balunless ATE from AESA

ABBREVIATIONS

<table>
<thead>
<tr>
<th>Name</th>
<th>Abbreviation</th>
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<tr>
<td>Cable under Test</td>
<td>CUT</td>
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<tr>
<td>Device under Test</td>
<td>DUT</td>
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<tr>
<td>Equal Level Transverse</td>
<td>EL TCTL</td>
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<td>Conversion Transfer Loss</td>
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